L Number	Hits	Search Text	DB	Time stamp
1	15299	(land or pad) and (air with (vent or hole or escape or space))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/09 03:38
2	3809	((land or pad) and (air with (vent or hole or escape or space))) and flange	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/09 03:37
3	3663	(((land or pad) and (air with (vent or hole or escape or space))) and flange) and (@ad<20001205)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/09 03:40
4	753	((((land or pad) and (air with (vent or hole or escape or space))) and flange) and (@ad<20001205)) and (carrier or substrate)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/09 03:38
5	15564	(land or pad) and (air with (vent or hole or slit or escape or space))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/09 03:38
6	677	(land or pad) with (air near (vent or hole or slit or escape or space))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/09 03:39
8	1	("5962922").PN.	USPAT	2002/07/09 03:44
9	0	5962922.URPN.	USPAT	2002/07/09 03:48
10	0	5962922.URPN.	USPAT	2002/07/09 03:50
11	0	5962922.URPN.	USPAT	2002/07/09 03:50
12	7	("4664962" | "5315072" | "5404044" | "5406034" | "5541368" | "5689091" | "5783865").PN.	USPAT	2002/07/09 03:51
7	638	((land or pad) with (air near (vent or hole or slit or escape or space))) and (@ad<20001205)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/09 04:00
13	1402	257/773.ccls. and (@ad<20001205)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/09 04:02
14	14803	257/$.ccls. and (@ad<20001205) and (pad or land)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/09 04:02
15	451	(257/773.ccls. and (@ad<20001205)) and (pad or land)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/09 04:02
16	119947	257/$.ccls. and (@ad<20001205)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/09 04:03
17	245	(257/$.ccls. and (@ad<20001205) and (pad or land)) and ((land or pad) and (air with (vent or hole or escape or space)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/09 04:03

L Number	Hits	Search Text	DB	Time stamp
1	236	csp and land and substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/09 05:07
2	151	(csp and land and substrate) and (@ad<20001205)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/09 05:08
3	137	((csp and land and substrate) and (@ad<20001205)) and chip	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2002/07/09 05:08